



BALL A1 CORNER

DЗ

NOTE 12 (D4)

IBGA63 9x9 CASE 503AY **ISSUE C** SCALE 1:1

NULE 15

(E4)

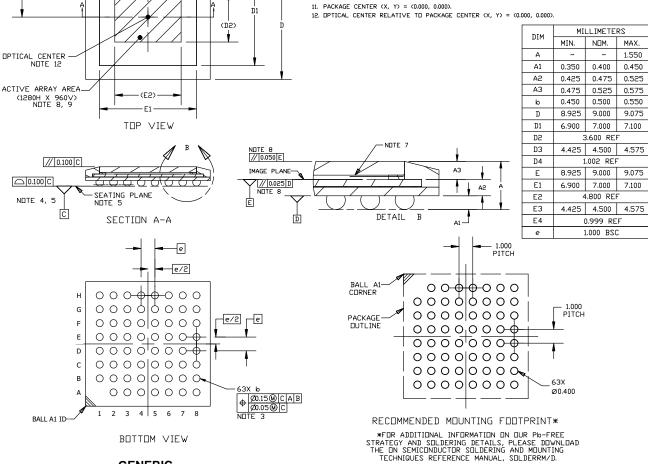
FIRST ACTIVE

PIXEL NOTE 10

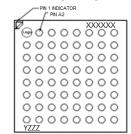
DATE 06 JAN 2023

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS [mm].

 SOLDER BALL DIAMETER IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER PARALLEL TO DATUM C.
- COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- DATUM C, THE SEATING PLANE IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- GLASS: 0.400 THICKNESS; REFRACTIVE INDEX = 1.52; AR CDATING R(1% 420-850nm (EACH SIDE). AIR GAP BETWEEN GLASS AND PIXEL ARRAY: 0.125 THICKNESS.
- PARALLELISM APPLIES ONLY TO THE ACTIVE ARRAY.
- MAXIMUM ROTATION OF ACTIVE ARRAY RELATIVE TO DATUMS A AND B IS \pm 0.5°
- 10. REFER TO THE DEVICE DATA SHEET FOR TOTAL PIXEL ARRAY DEFINITIONS.



GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

Υ = Year

ZZZ = Lot Traceability

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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| DESCRIPTION: | BGA63 9X9 | | PAGE 1 OF 1 |

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